



# N-Channel 20-V (D-S) MOSFET

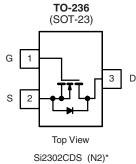
PRODUCT SUMMARY					
V <sub>DS</sub> (V)	$R_{DS(on)}(\Omega)$	I <sub>D</sub> (A)	Q <sub>g</sub> (Typ.)		
20	$0.057$ at $V_{GS} = 4.5 \text{ V}$	2.9	3.5		
	0.075 at V <sub>GS</sub> = 2.5 V	2.6	3.5		

#### **FEATURES**

- Halogen-free Option Available
  TrenchFET<sup>®</sup> Power MOSFET

#### **APPLICATIONS**

- · Load Switching for Portable Devices
- DC/DC Converter



\* Marking Code

Ordering Information: Si2302CDS-T1-E3 (Lead (Pb)-free)

Si2302CDS-T1-GE3 (Lead (Pb)-free and Halogen-free)

ABSOLUTE MAXIMUM RATINGS TA	$_{\Lambda}$ = 25 °C, unle	ss otherwise r	noted			
Parameter		Symbol	5 s	Steady State	Unit	
Drain-Source Voltage		V <sub>DS</sub>	20		V	
Gate-Source Voltage		V <sub>GS</sub>	± 8			
Continuous Dunin Comment /T 150 °C\d	T <sub>A</sub> = 25 °C	I <sub>D</sub>	2.9	2.6		
Continuous Drain Current (T <sub>J</sub> = 150 °C) <sup>a</sup>	T <sub>A</sub> = 70 °C		2.3	2.1		
Pulsed Drain Current <sup>b</sup>		I <sub>DM</sub>	10		Α	
Continuous Source Current (Diode Conduction) <sup>a</sup>		I <sub>S</sub>	0.72	0.6		
Developing the discontinual	T <sub>A</sub> = 25 °C	P <sub>D</sub>	0.86	0.71	W	
Power Dissipation <sup>a</sup>	T <sub>A</sub> = 70 °C		0.55	0.46		
Operating Junction and Storage Temperature Range		T <sub>J</sub> , T <sub>stg</sub>	- 55 to 150		°C	

THERMAL RESISTANCE RATINGS					
Parameter		Symbol	Typical	Maximum	Unit
Maniana la Ambianta	t ≤ 5 s	- R <sub>thJA</sub>	120	145	°C/W
Maximum Junction-to-Ambient <sup>a</sup>	Steady State		140	175	
Maximum Junction-to-Foot	Steady State	R <sub>thJF</sub>	62	78	

- a. Surface Mounted on 1" x 1" FR4 board.
- b. Pulse width limited by maximum junction temperature.

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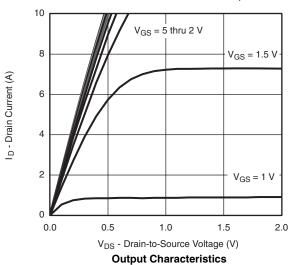
		otherwise noted	Limits				
Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static							
Drain-Source Breakdown Voltage	$V_{DS}$	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$	20			V	
Gate-Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	0.40		0.85	V	
Gate-Body Leakage	I <sub>GSS</sub>	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 8 \text{ V}$	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 8 \text{ V}$		± 100	nA	
7 0	I <sub>DSS</sub>	V <sub>DS</sub> = 20 V, V <sub>GS</sub> = 0 V	, V <sub>GS</sub> = 0 V		1		
Zero Gate Voltage Drain Current		V <sub>DS</sub> = 20 V, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 70 °C			75	μΑ	
On-State Drain Current <sup>a</sup>	I <sub>D(on)</sub>	$V_{DS} \ge 10 \text{ V}, V_{GS} = 4.5 \text{ V}$	6			Α	
	Б	$V_{GS} = 4.5 \text{ V}, I_D = 3.6 \text{ A}$		0.045	0.057		
Drain-Source On-Resistance <sup>a</sup>	R <sub>DS(on)</sub>	V <sub>GS</sub> = 2.5 V, I <sub>D</sub> = 3.1 A		0.056	0.075	Ω	
Forward Transconductance <sup>a</sup>	9 <sub>fs</sub>	$V_{DS} = 5 \text{ V}, I_D = 3.6 \text{ A}$		13		S	
Diode Forward Voltage	$V_{SD}$	I <sub>S</sub> = 0.95 A, V <sub>GS</sub> = 0 V		0.7	1.2	V	
Dynamic <sup>b</sup>			· I	1			
Total Gate Charge	$Q_g$			3.5	5.5		
Gate-Source Charge	$Q_{gs}$	$V_{DS} = 10 \text{ V}, V_{GS} = 4.5 \text{ V}, I_{D} = 3.6 \text{ A}$		0.6		nC	
Gate-Drain Charge	$Q_{gd}$			0.45			
Gate Resistance	$R_{g}$	f = 1.0 MHz	2.0	4.0	8.0	Ω	
Switching				•			
Turn-On Delay Time	t <sub>d(on)</sub>			8	15		
Rise Time	t <sub>r</sub>	$V_{DD} = 10 \text{ V}, R_{L} = 2.78 \Omega$		7	15	ns	
Turn-Off Delay Time	t <sub>d(off)</sub>	$\text{I}_\text{D}\cong 3.6~\text{A},~\text{V}_\text{GEN}=4.5~\text{V},~\text{R}_\text{g}=1~\Omega$		30	45		
Fall Time	t <sub>f</sub>			7	15		
Source-Drain Reverse Recovery Time	t <sub>rr</sub>	L = 3.6 A dl/dt = 100 A/vo		8.5	15		
Body Diode Reverse Recovery Charge	Q <sub>rr</sub>	$I_F = 3.6 \text{ A}, \text{ dI/dt} = 100 \text{ A/}\mu\text{s}$		2.0	4.0	nC	

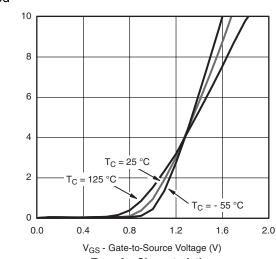
#### Notes:

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

I<sub>D</sub> - Drain Current (A)

### TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



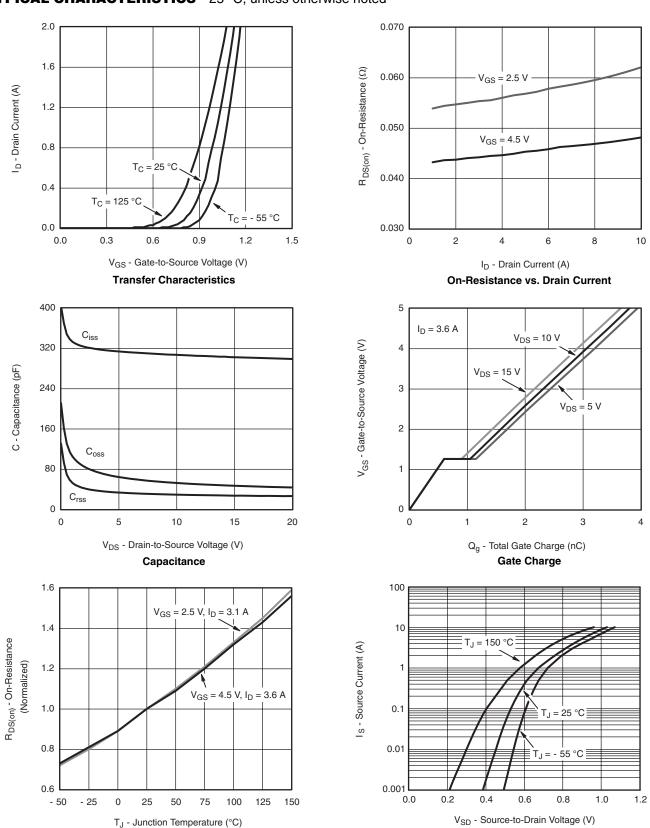


a. Pulse test: Pulse width  $\leq$  300  $\mu$ s, duty cycle  $\leq$  2 %.

b. Guaranteed by design, not subject to production testing.



### TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



On-Resistance vs. Junction Temperature

Source-Drain Diode Forward Voltage

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4

2

0.01

0.1

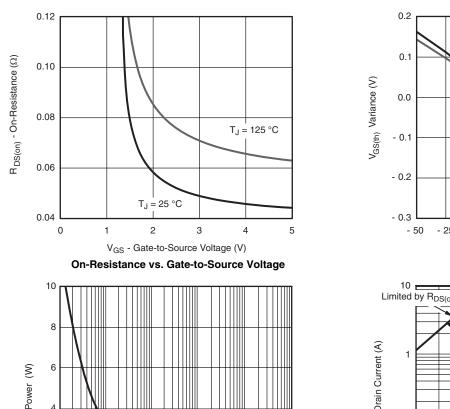
1

Time (s)

Single Pulse Power

10

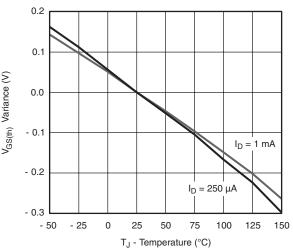
### TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



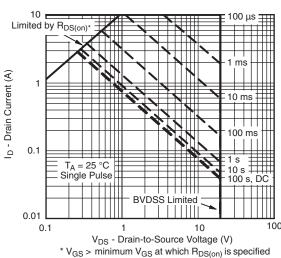
T<sub>A</sub> = 25 °C

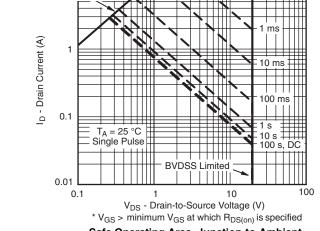
100

1000

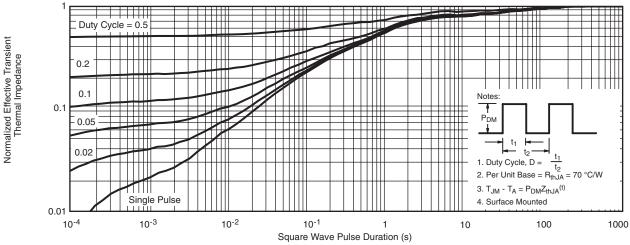


**Threshold Voltage** 









Normalized Thermal Transient Impedance, Junction-to-Ambient

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